SiPMs for XAMS: A dual-phase liquid xenon TPC for dark matter direct detection R&D

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OUTLINE

■ XAMS & SiPMs

■ SiPM characterization setup

■ Field measurements with XAMS & future TPCs
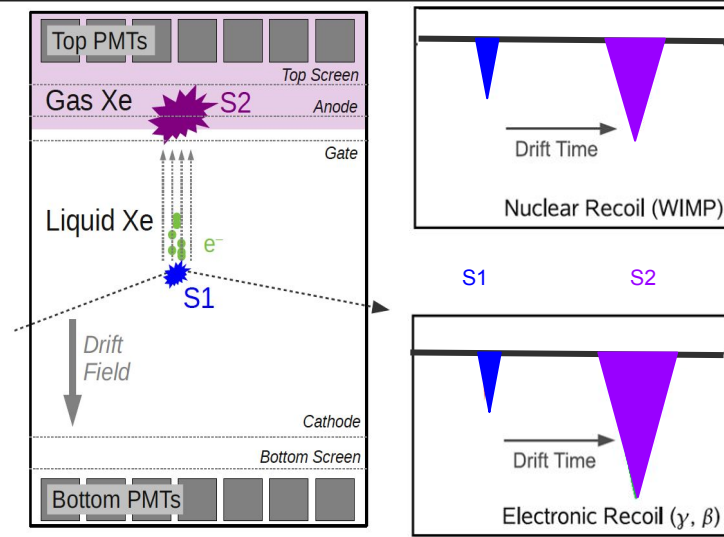
Dark-Phase TPC

Application:
- dark matter direct detection
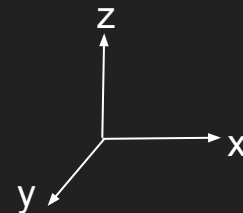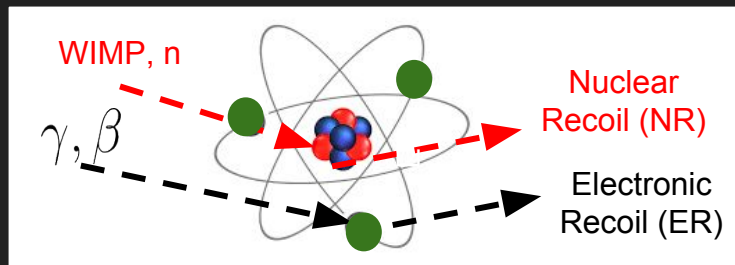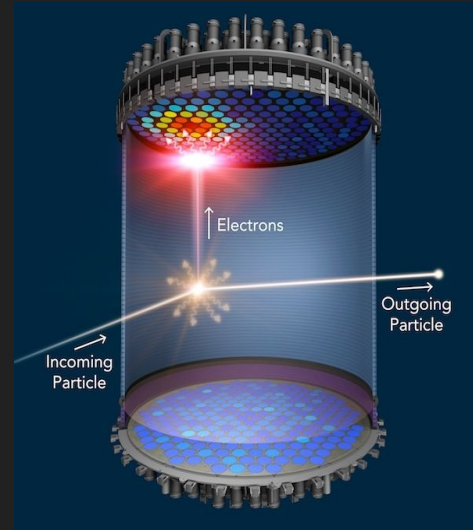
Working principle:
- ER & NR
- S1 & S2 signals
- S2/S1 discrimination
- position reconstruction
  - z ⟶ drift time
  - x,y ⟶ light distribution

TPC working principle

Top PMTs

Top Screen

Gas Xe — S2 — Anode

Gate

Liquid Xe — e⁻

S1

Drift Field

Cathode

Bottom Screen

Bottom PMTs

signals

S1 | S2

Drift Time

Nuclear Recoil (WIMP)

S1 | S2

Drift Time

Electronic Recoil (γ, β)

S2 light distribution

Electrons

Outgoing Particle

Incoming Particle

WIMP, n

γ, β

Nuclear Recoil (NR)

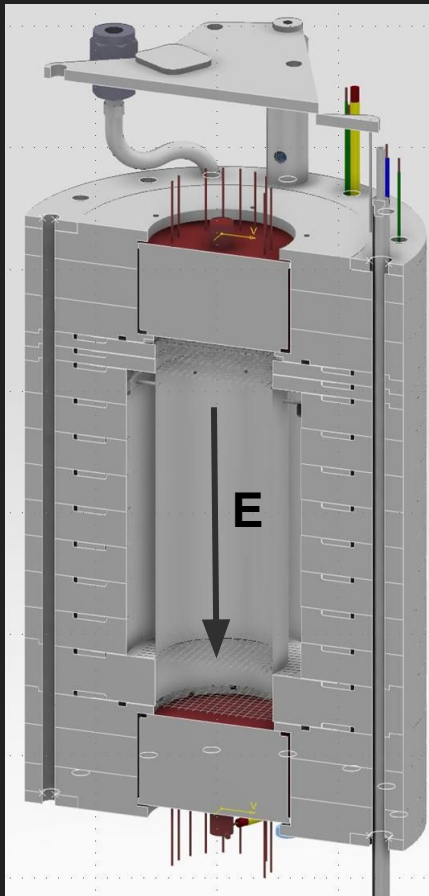Electronic Recoil (ER)

z

x

y

XAMS

What is XAMS?
- dual-phase Xe TPC R&D

Why XAMS?
- properties of Xe TPCs
  - scintillation and ionization signals
  - charge transport dynamics
  - xenon purity & backgrounds
  - field dependencies (this talk)

Limitation:
- single PMTs
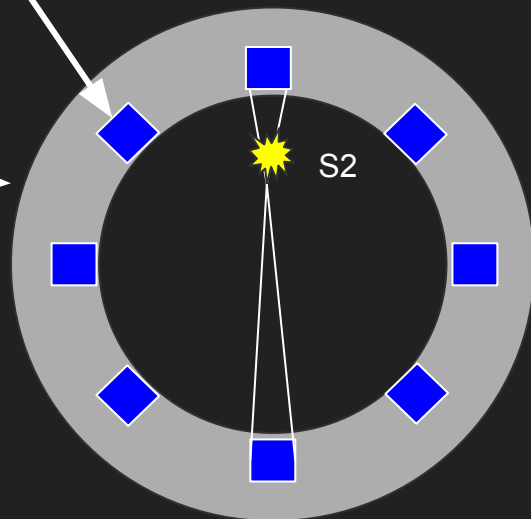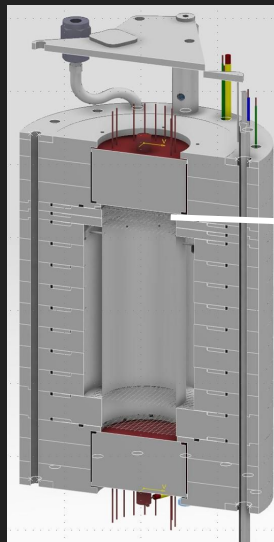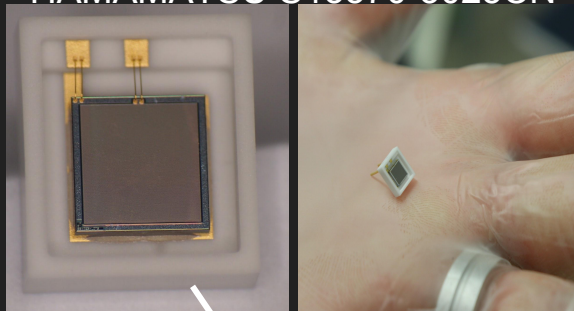 - lateral position reconstruction (x,y)

SiPMs

SiPMs for XAMS:
- lateral position reconstruction
  - SiPM ring in GXe
  - relative response
  - compare with simulation

What is a SiPM?
- solid state photodetector
  - single photon sensitivity
  - ~24% photon detection efficiency for LXe (178 nm)
  - cryogenic stability with reduced noise
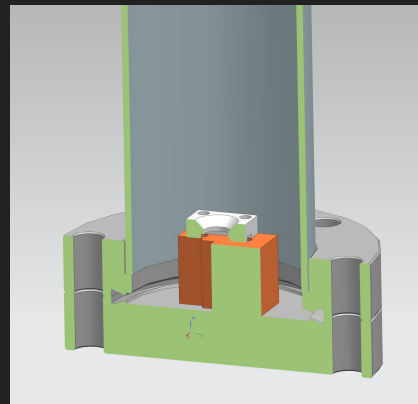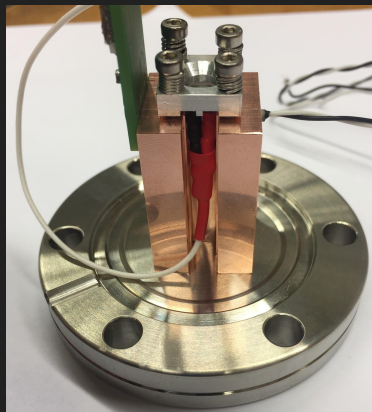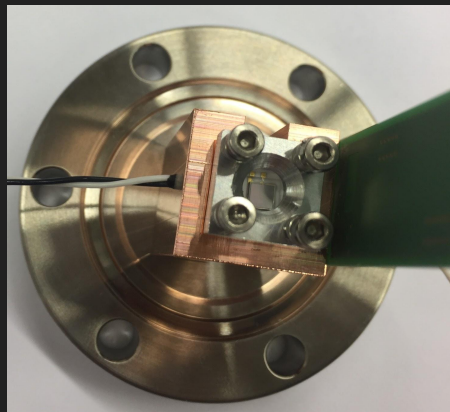 - low voltage + high gain
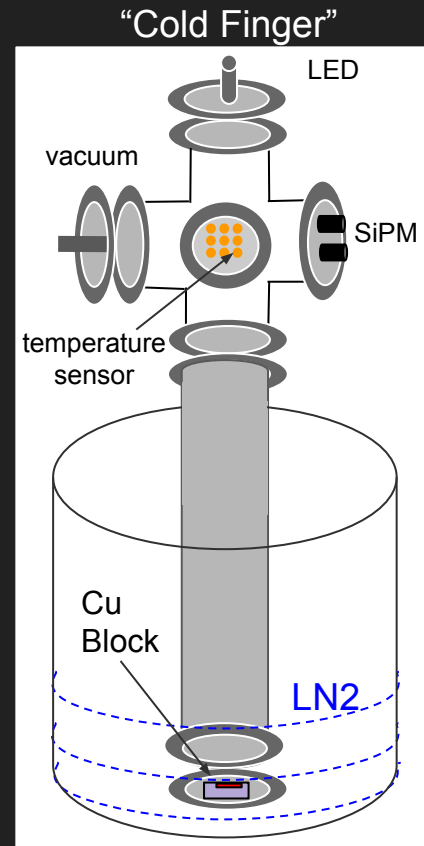

S2

SiPM Characterization

What is the Cold Finger?
- SiPM characterization setup

Characterization:
- SiPMs' temperature dependence
(gain, noise, bias, etc.)

Drawing by Martin Doets

"Cold Finger"

LED

vacuum

SiPM

temperature
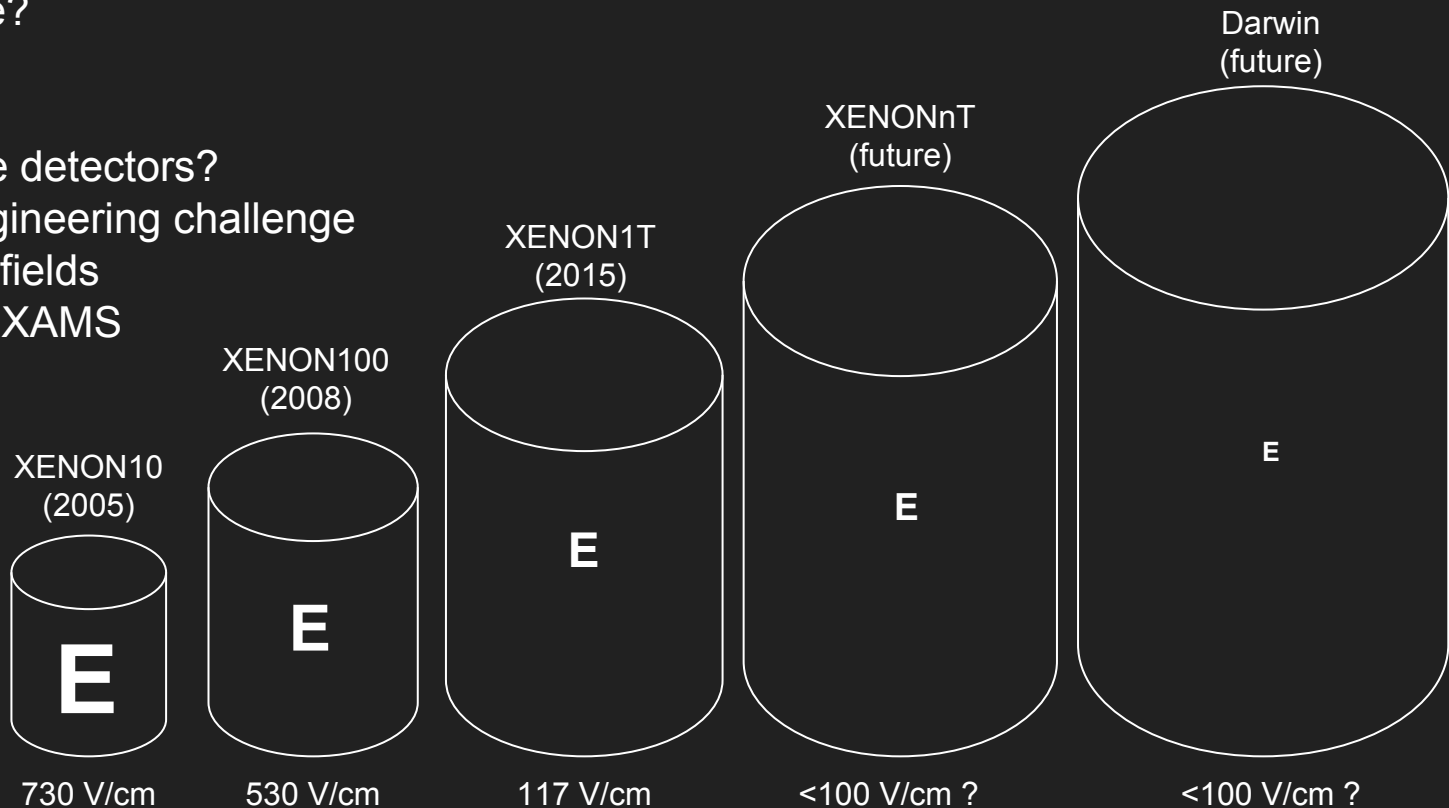sensor

Cu
Block

LN2

TPCs for DM Direct Detection

Why the growing size?
- exposure

Implications for future detectors?
- high voltage engineering challenge
- decreasing drift fields
  - probe with XAMS

XENON10
(2005)

XENON100
(2008)

XENON1T
(2015)

XENONnT
(future)

Darwin
(future)

730 V/cm   530 V/cm   117 V/cm   <100 V/cm ?   <100 V/cm ?
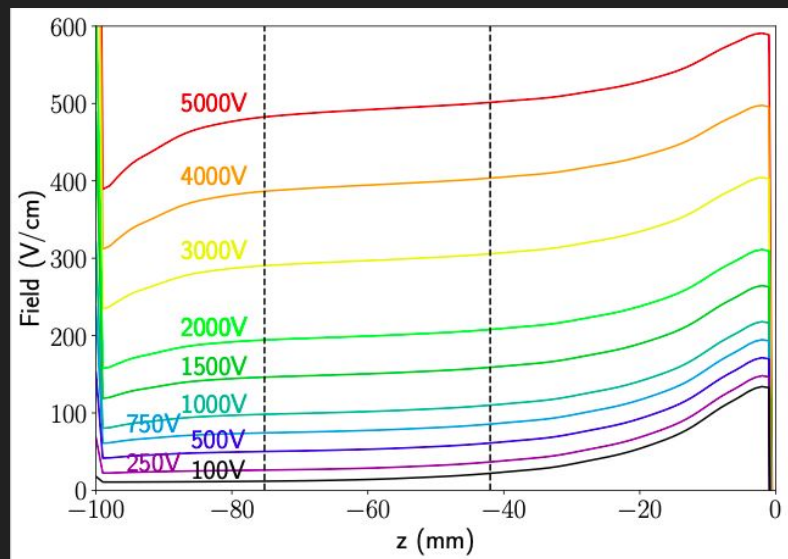
XAMS ER Studies

22Na source:
- beta decay
- 511 keV back-to-back photons
- triple coincidence (PMT1 + PMT2 + NaI)
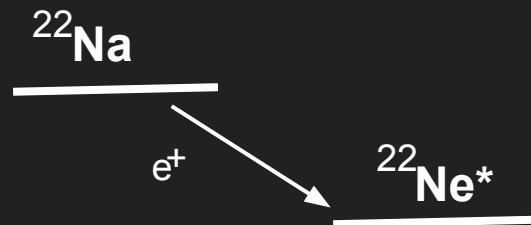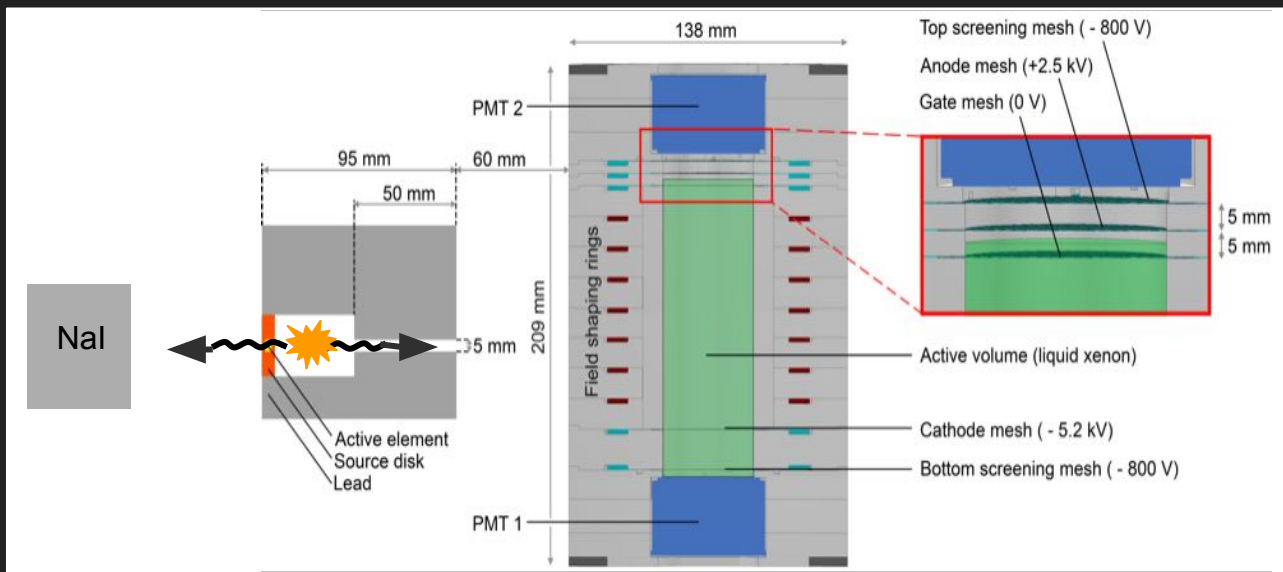
Drift Velocity vs Field
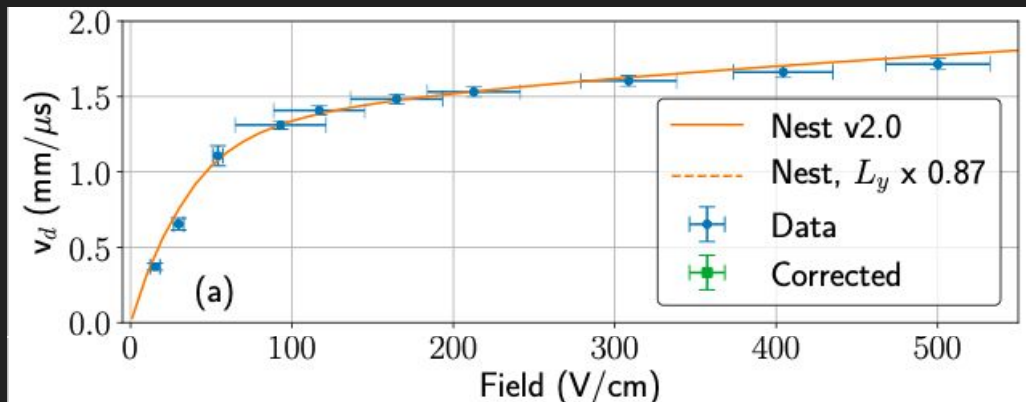
Uncertainties:
- field distortion (near anode + cathode)
- z-position (cathode location + travel time)
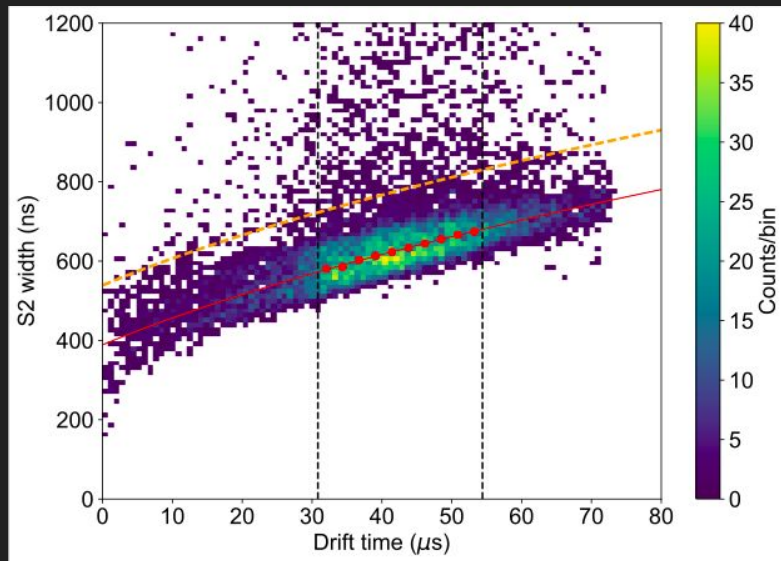

TPC bottom   TPC top

*NEST: Noble Element Simulation Technique
- excitation, ionization and scintillation of liquid noble elements
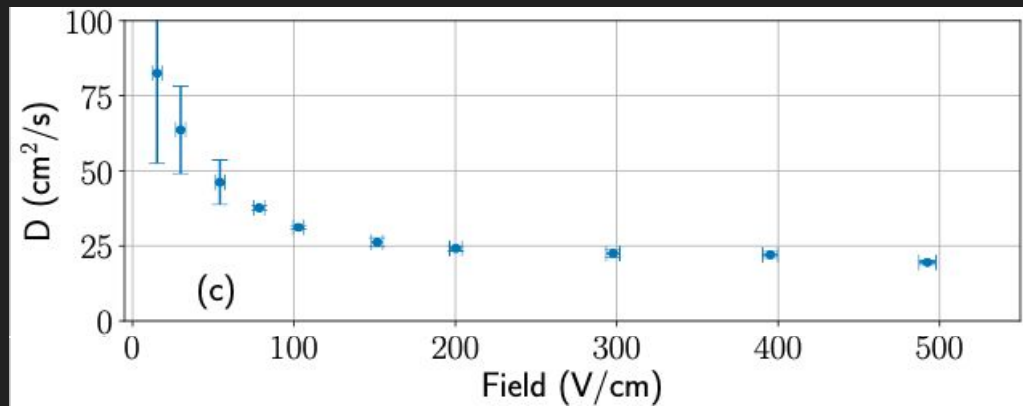
Diffusion vs Field

S2 width:
- electron diffusion
- higher fields $\longrightarrow$ fit
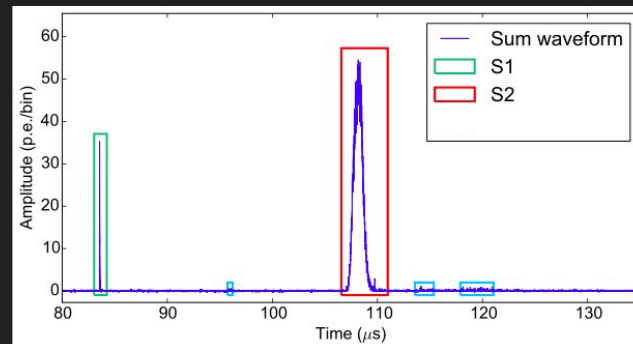- lowest 3 fields $\longrightarrow$ drift time slice

TPC bottom

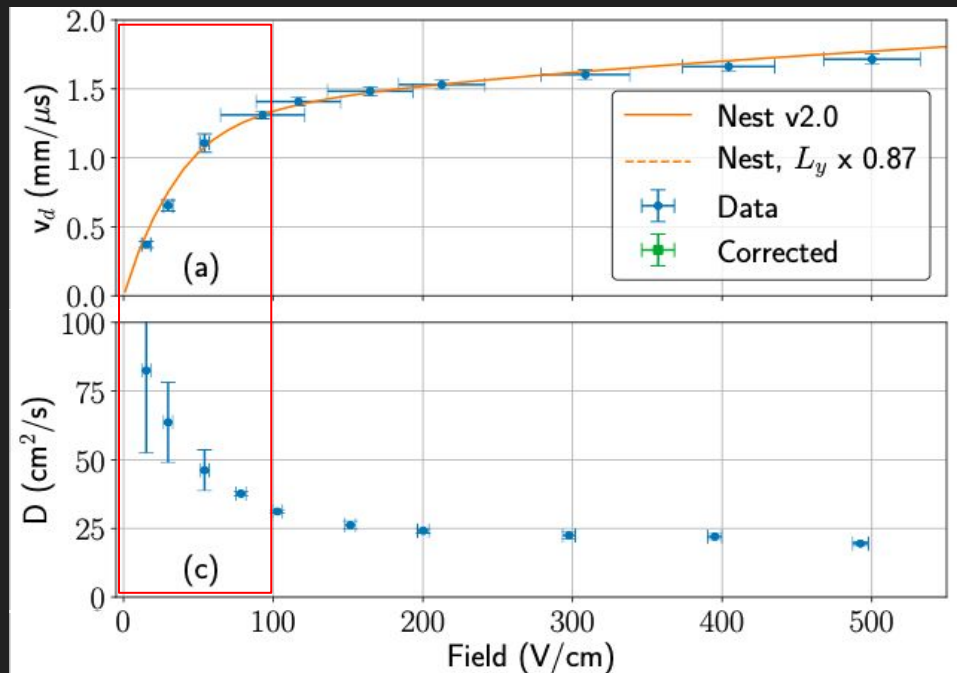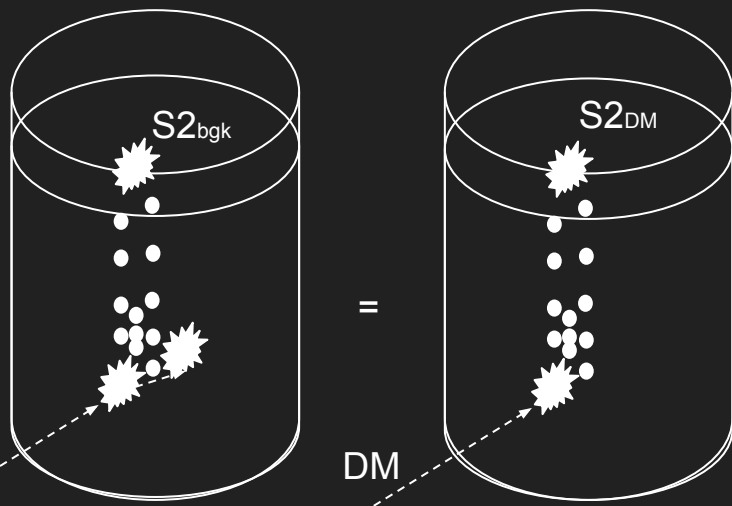$$\sigma_{S2} = \sqrt{\frac{2Dt_d(z)}{v_d^2} + \sigma_0^2}$$

$$\frac{d\sigma_{S2}^2}{dt_d} = \frac{2D(z(E))}{v_d^2}$$

TPC top

Future TPCs

Implication for dark matter (DM) search:
- low V_d + high D
  - wide S2
  - multiple scatter background
    - z-position resolution
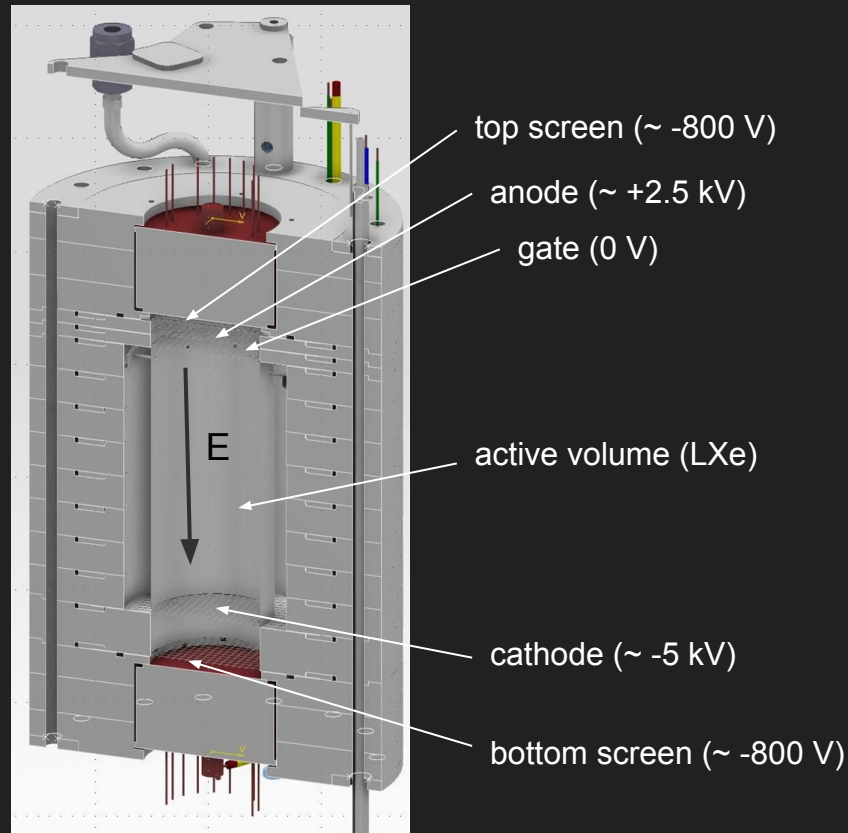

S2$_{bgk}$

S2$_{DM}$

=

n

DM

LIMITING SENSITIVITY TO DM SEARCH!

Conclusion

■ XAMS - TPC R&D for dark matter direct detection

■ SiPM characterization for lateral position reconstruction in XAMS

■ XAMS field measurements for multiple scatter backgrounds in future (larger) TPCs
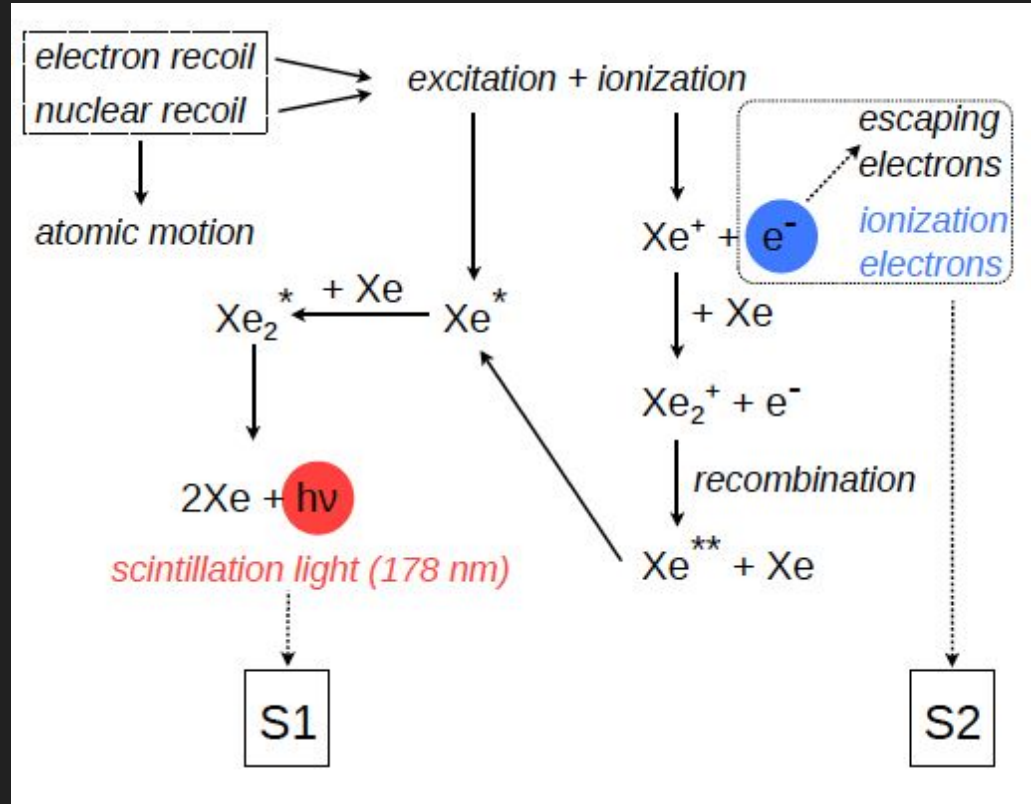
BACKUP

XAMS Description

- "Xenon Amsterdam"
- dual-phase TPC
  - PTFE
  - 154cm^3 active volume (Ø45 x 100 mm)
  - ~430g LXe at -90°C
  - PMT1 & PMT2 (UV sensitive - 178 nm)
  - 7 field shaping rings (resistor chain)
  - 5 meshes

top screen (~ -800 V)

anode (~ +2.5 kV)

gate (0 V)

E

active volume (LXe)

cathode (~ -5 kV)

bottom screen (~ -800 V)

Scintillation in Xe

Xe* = exciton

Xe2* = excimer

XAMS Signal Corrections

Nik|hef

cS1:
- z-position dependence
  - opening angle
  - PTFE reflection
  - absorption by meshes and impurities
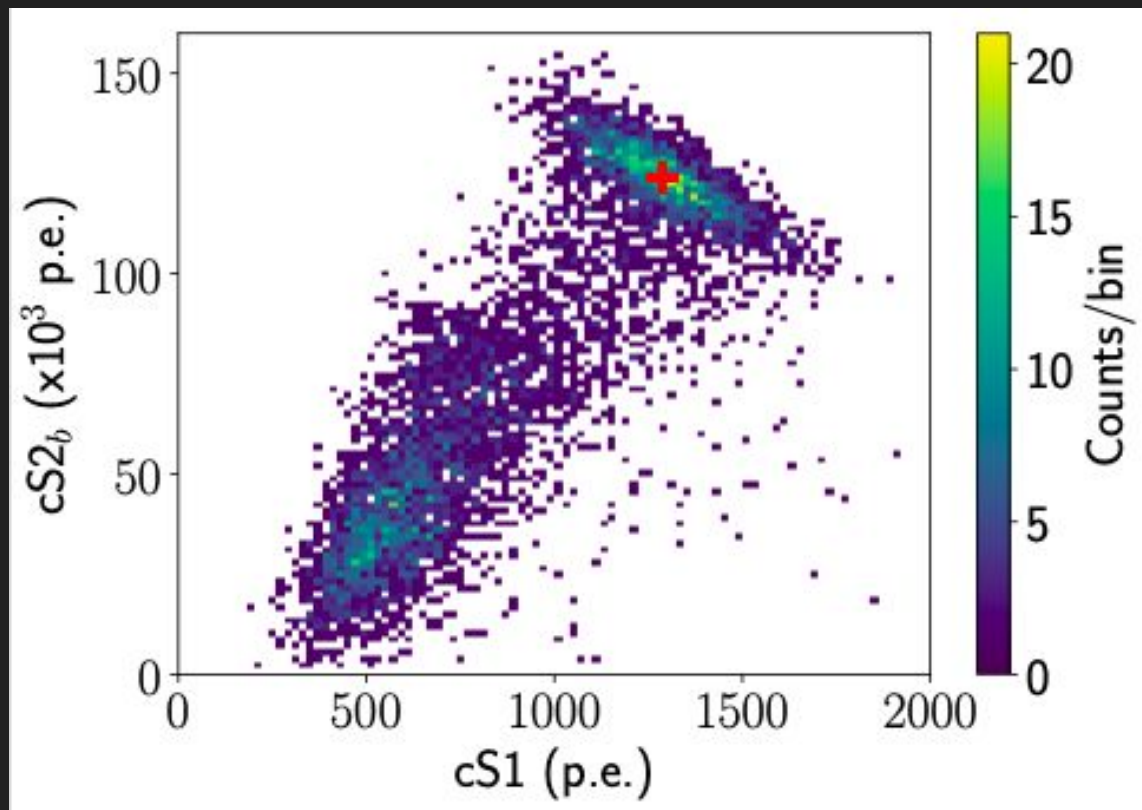
cS2:
- electron lifetime
  - xenon purity

arXiv:1602.01974

(a)

(b)
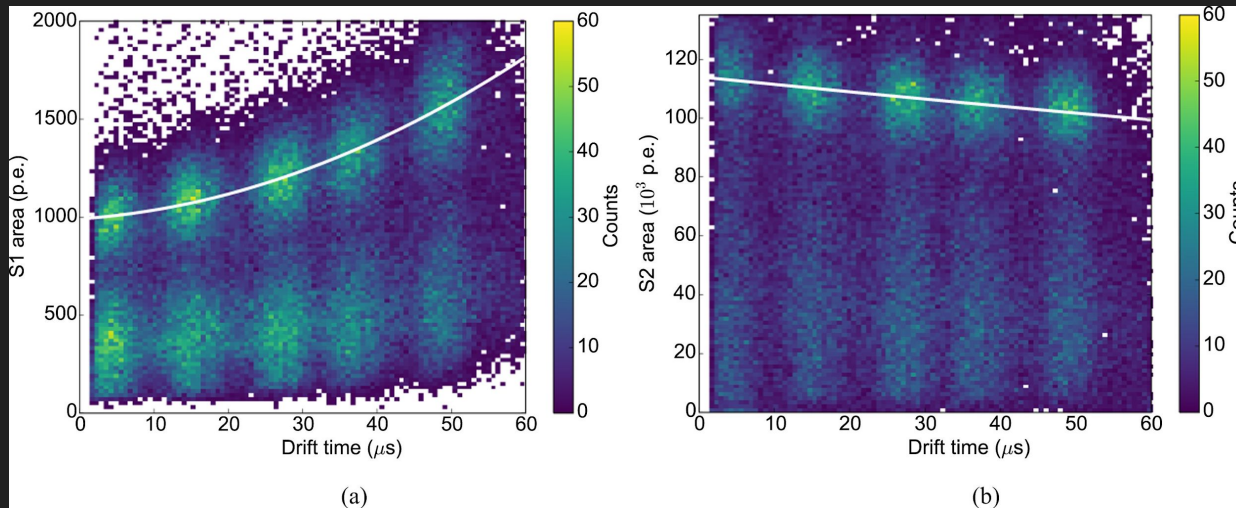
low drift time $\longrightarrow$ TPC top

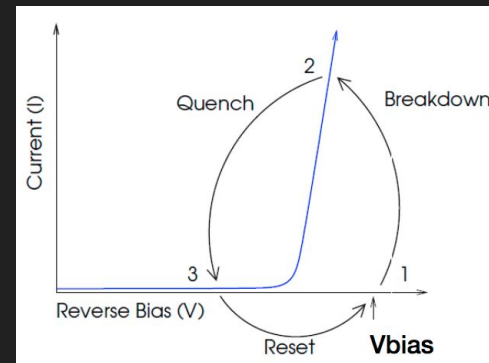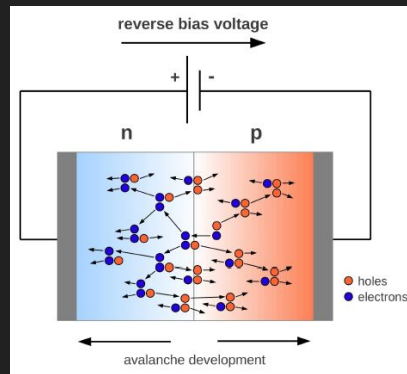high drift time $\longrightarrow$ TPC bottom
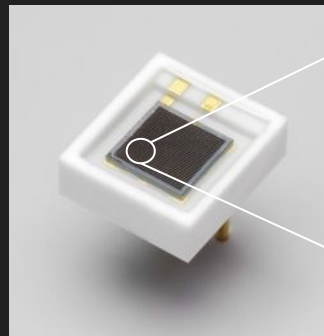
XAMS cS2 vs cS1

SiPMs

What is an SiPM?

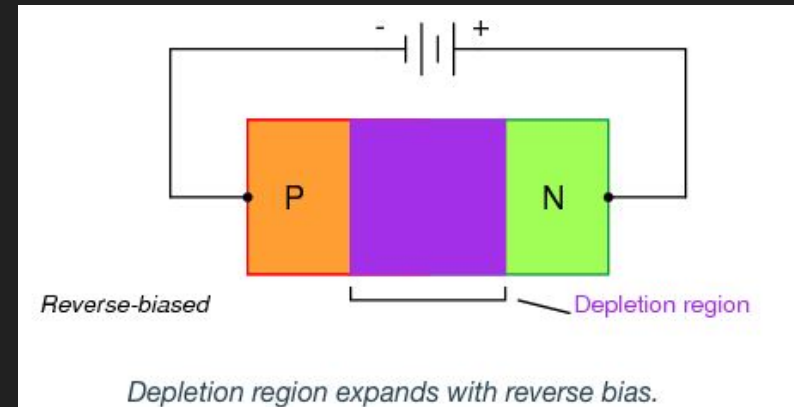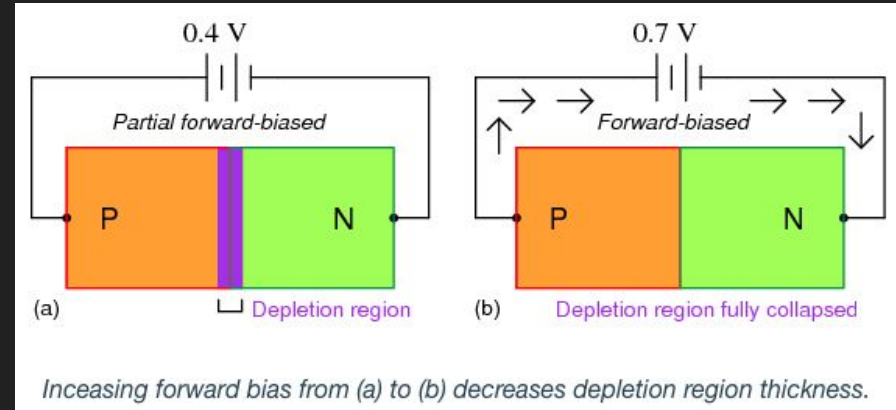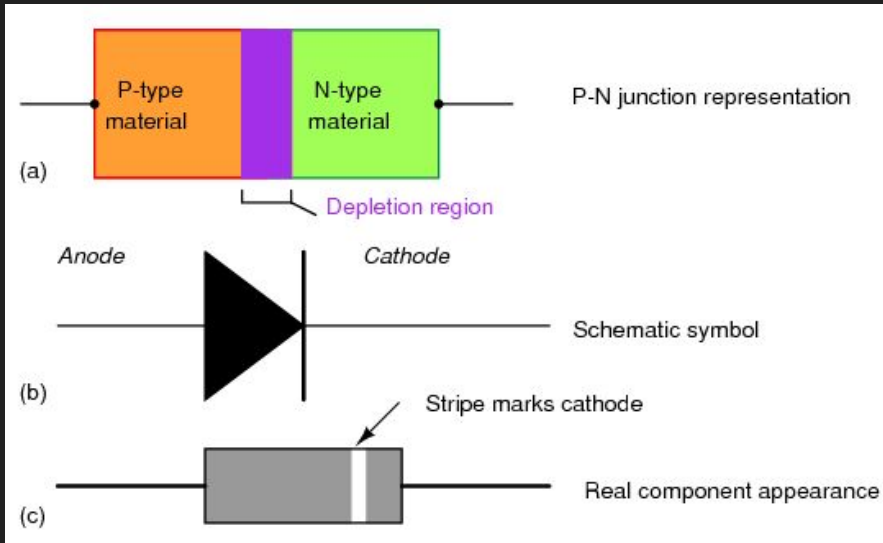- solid state photodetector
- cells in parallel: G-APD + quenching

How does it work?

- SiPM in "Geiger mode" ($V_{bias} > V_{br}$)
- photon creates e^-/h^+ pair
- charge carriers impact ionize, creating an avalanche (current)
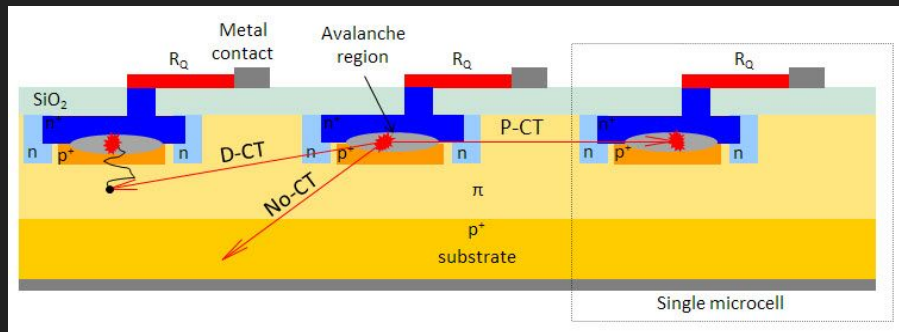- current is quenched and G-mode is restored
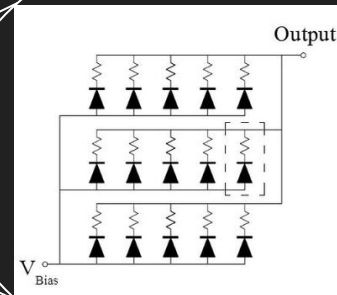
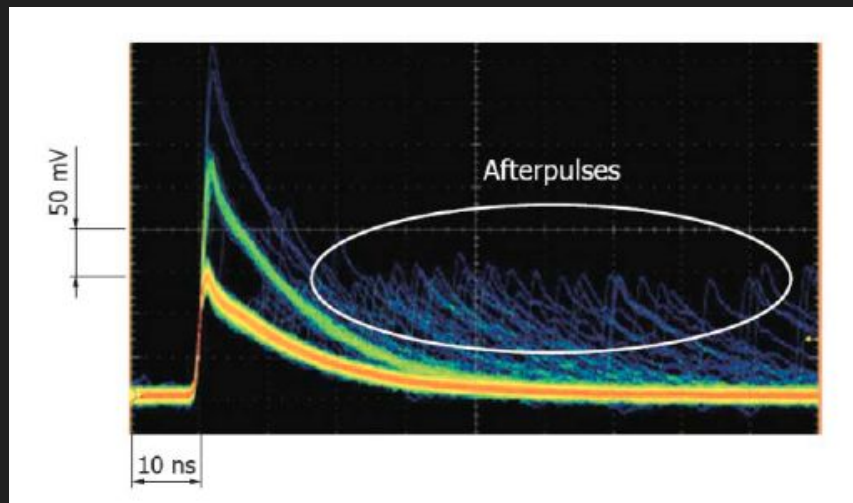# Diodes

Noise in SiPMs

Noise sources in SiPM?
- Dark Count Rate
  - thermally generated
- Afterpulses
  - charge de-trapping
- Optical Crosstalk
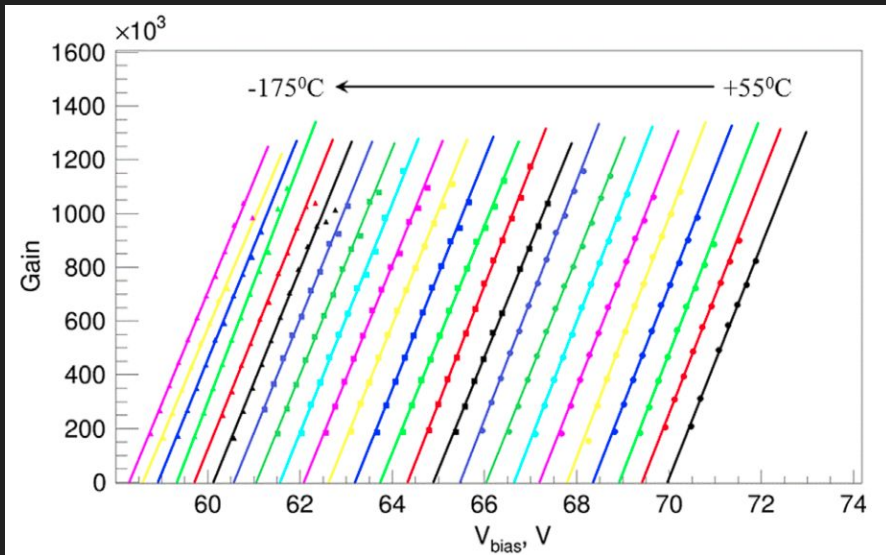 - charge carrier photon emission

How to identify noise?
- Dark Count Rate
  - measurements in dark condition
- Afterfulses
  - pulse height + time delay
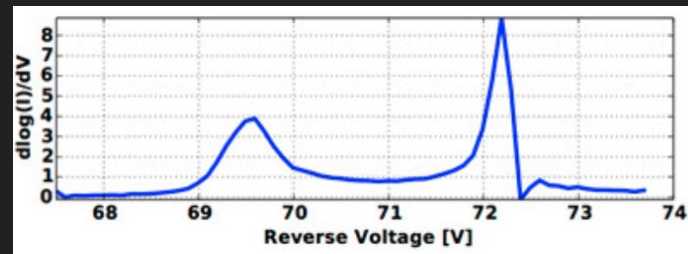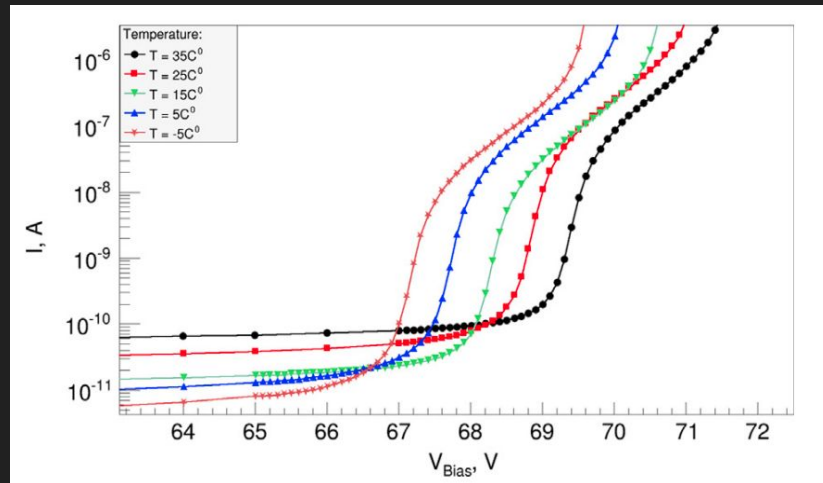- Optical Crosstalk
  - time delay

SiPM Gain Measurements

Example Result
(N. Dinu et al. 2014)

Example Result
(N. Dinu et al. 2014)

$$G_{mc} = \frac{Q}{e} = \frac{\int I(t)dt}{e} = \frac{\int V_{out}(t)dt}{R_{load}G_{amp}e} = \frac{C_J\Delta V}{e}$$
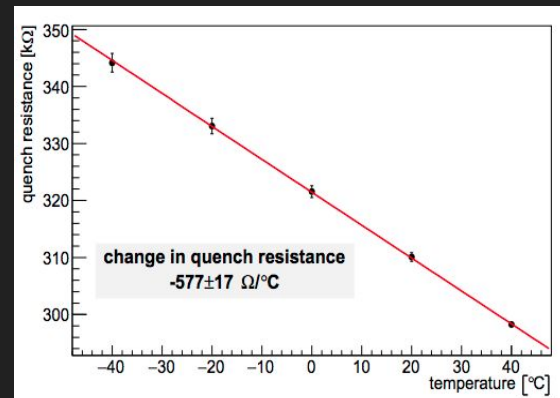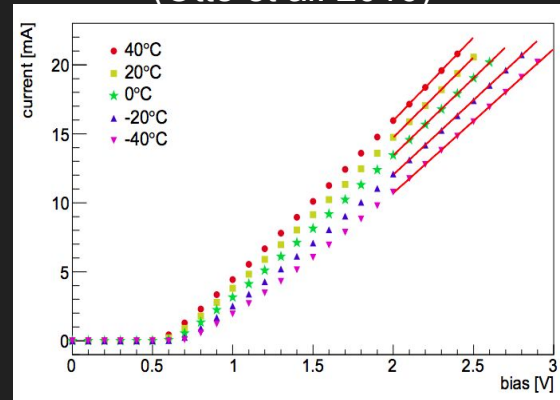
SiPM R$_Q$ Measurements

$$\frac{1}{R_{Q_{tot}}} = \sum_{i=1}^{N} \frac{1}{R_i} = \frac{N}{R_i} \rightarrow R_i = \frac{N}{R_{Q_{tot}}}$$

Example Result
(Otte et al. 2016)

change in quench resistance
-577±17 Ω/°C

SiPM DCR Measurements

Example Result
(N. Dinu et al. 2014)